Intelligent Power Module (IPM)
1200 V, 10 A

Advance Information

NFAM1012L5B

The NFAM1012L5B is a fully−integrated inverter power module consisting of an independent High side gate driver, LVIC, six IGBT's and a temperature sensor (TSU by LVIC), suitable for driving permanent magnet synchronous (PMSM) motors, brushless DC (BLDC) motors and AC asynchronous motors. The IGBT's are configured in a three−phase bridge with separate emitter connections for the lower legs for maximum flexibility in the choice of control algorithm.

The power stage has under−voltage lockout protection (UVP). Internal boost diodes are provided for high side gate boost drive.

Features

- Three−phase 1200 V, 10 A IGBT Module with Independent Drivers
- Active Logic Interface
- Built−in Under−voltage Protection (UVP)
- Integrated Bootstrap Diodes and Resistors
- Separate Low−side IGBT Emitter Connections for Individual Current Sensing of Each Phase
- Temperature Sensor (TSU Output by LVIC)
- UL Certification: E339285
- This is a Pb−Free Device

Typical Application

- Industrial Drives
- Industrial Pumps
- Industrial Fans
- Industrial Automation

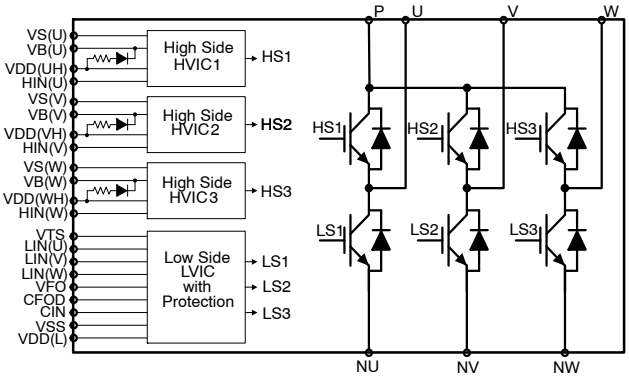
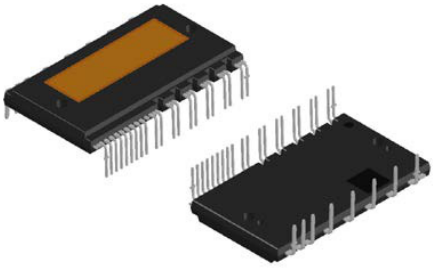


Figure 1. Application Schematic

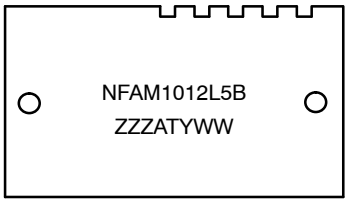
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CASE MODGX
DIP39, 54.5x31.0 EP−2

MARKING DIAGRAM



NFAM1012L5B = Specific Device Code
ZZZ = Assembly Lot Code
A = Assembly Location
T = Test Location
Y = Year
WW = Work Week
Device marking is on package top side

ORDERING INFORMATION

Device	Package	Shipping† (Qty / Packing)
NFAM1012L5B	DIP39, 31.0x54.5 (Pb−Free)	90 / BOX

This document contains information on a new product. Specifications and information herein are subject to change without notice.

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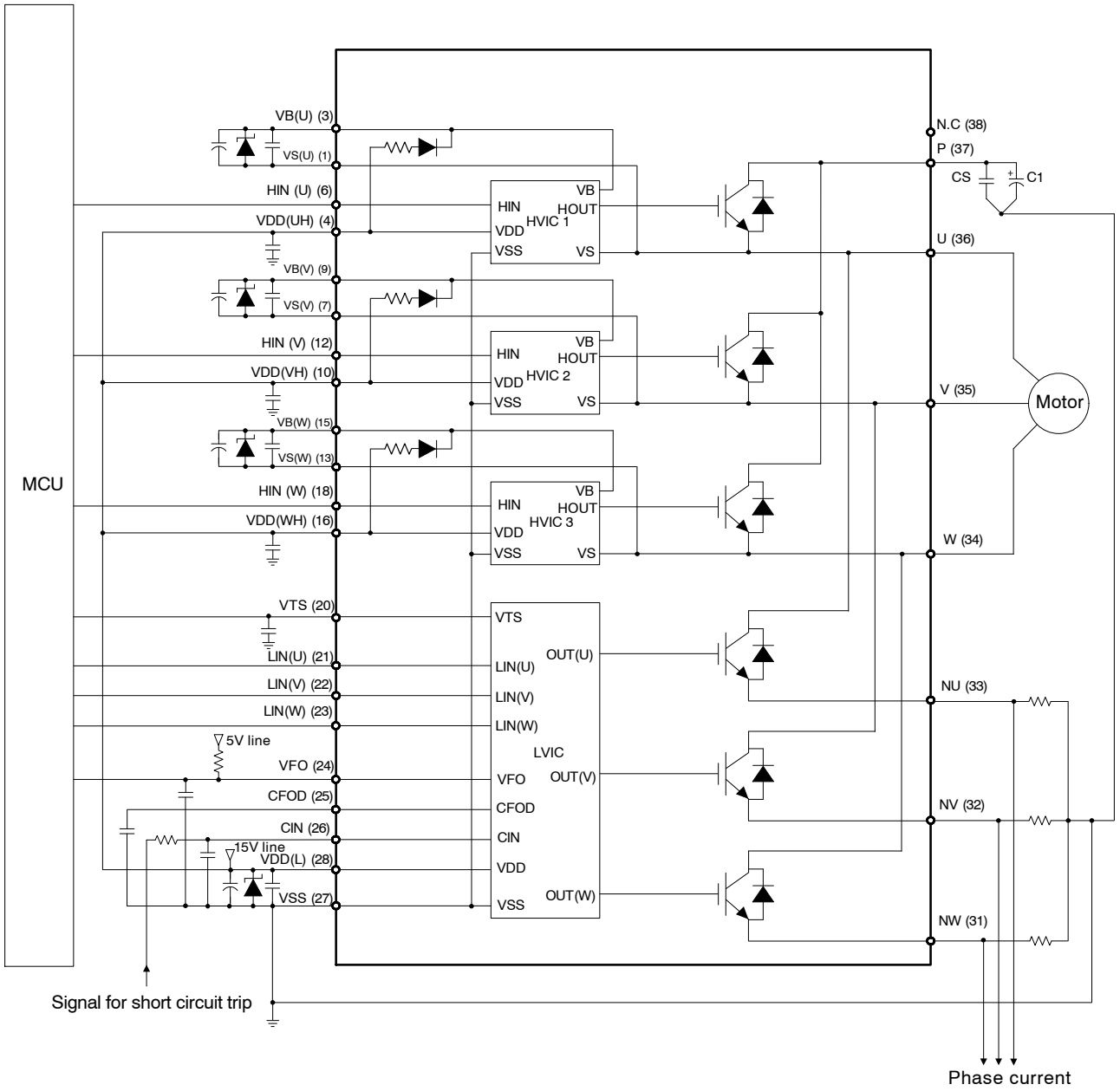


Figure 2. Application Schematic − Adjustable Option

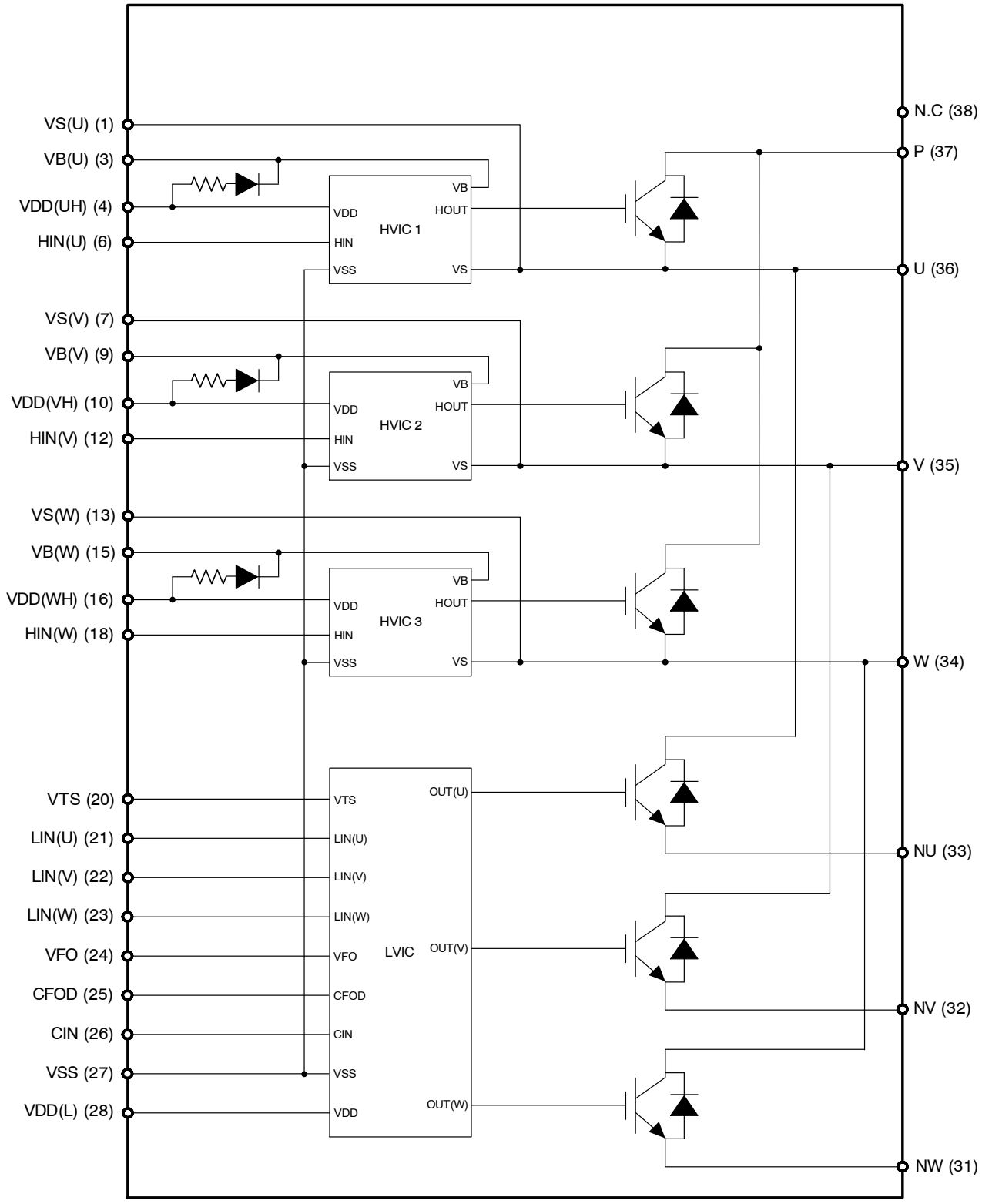


Figure 3. Equivalent Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

Pin	Name	Description
1	VS(U)	High−Side Bias Voltage GND for U Phase IGBT Driving
(2)	−	Dummy
3	VB(U)	High−Side Bias Voltage for U Phase IGBT Driving
4	VDD(UH)	High−Side Bias Voltage for U Phase IC
(5)	−	Dummy
6	HIN(U)	Signal Input for High−Side U Phase
7	VS(V)	High−Side Bias Voltage GND for V Phase IGBT Driving
(8)	−	Dummy
9	VB(V)	High−Side Bias Voltage for V Phase IGBT Driving
10	VDD(VH)	High−Side Bias Voltage for V Phase IC
(11)	−	Dummy
12	HIN(V)	Signal Input for High−Side V Phase
13	VS(W)	High−Side Bias Voltage GND for W Phase IGBT Driving
(14)	−	Dummy
15	VB(W)	High−Side Bias Voltage for W Phase IGBT Driving
16	VDD(WH)	High−Side Bias Voltage for W Phase IC
(17)	−	Dummy
18	HIN(W)	Signal Input for High−Side W Phase
(19)	−	Dummy
20	VTS	Voltage Output for LVIC Temperature Sensing Unit
21	LIN(U)	Signal Input for Low−Side U Phase
22	LIN(V)	Signal Input for Low−Side V Phase
23	LIN(W)	Signal Input for Low−Side W Phase
24	VFO	Fault Output
25	CFOD	Capacitor for Fault Output Duration Selection
26	CIN	Input for Current Protection
27	VSS	Low−Side Common Supply Ground
28	VDD(L)	Low−Side Bias Voltage for IC and IGBTs Driving
(29)	−	Dummy
(30)	−	Dummy
31	NW	Negative DC−Link Input for U Phase
32	NV	Negative DC−Link Input for V Phase
33	NU	Negative DC−Link Input for W Phase
34	W	Output for U Phase
35	V	Output for V Phase
36	U	Output for W Phase
37	P	Positive DC−Link Input
38	N.C	No Connection
(39)	−	Dummy

Table 2. ABSOLUTE MAXIMUM RATINGS T_C = 25°C (Notes 1)

Rating	Symbol	Conditions	Value	Unit
Supply Voltage	VPN	P – NU, NV, NW	900	V
Supply Voltage (Surge)	VPN(Surge)	P – NU, NV, NW, (Note 2)	1000	V
Self Protection Supply Voltage Limit (Short−Circuit Protection Capability	VPN(PROT)	VDD = VBS = 13.5 V ~ 16.5 V, Tj = 150°C, Vces < 1200 V, Non−Repetitive, < 2 μs	800	V
Collector−Emitter Voltage	Vces		1200	V
Maximum Repetitive Revers Voltage	VRRM		1200	V
Each IGBT Collector Current	±Ic		±10	A
Each IGBT Collector Current (Peak)	±Icp	Under 1 ms Pulse Width	±20	A
Control Supply Voltage High−Side Control Bias Voltage	VDD	VDD(UH, VH, WH), VDD(L) – VSS	−0.3 to 20	V
	VBS	VB(U) – VS(U), VB(V) – VS(V), VB(W) – VS(W)	−0.3 to 20	V
Input Signal Voltage	VIN	HIN(U), HIN(V), HIN(W), LIN(U), LIN(V), LIN(W) – VSS	−0.3 to VDD	V
Fault Output Supply Voltage	VFO	VFO – VSS	−0.3 to VDD	V
Fault Output Current	IFO	Sink Current at VFO pin	2	mA
Current Sensing Input Voltage	VCIN	CIN – VSS	−0.3 to VDD	V
Corrector Dissipation	Pc	Per One Chip	83	W
Operating Junction Temperature	Ti		−40 to +150	°C
Storage Temperature	Tstg		−40 to +125	°C
Module Case Operation Temperature	Tc		−40 to +125	°C
Isolation Voltage	Viso	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat Sink Plate	2500	V rms

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.
2. This surge voltage developed by the switching operation due to the wiring inductance between P and NU, NV, NW terminal.

Table 3. THERMAL CHARACTERISTICS

Rating	Symbol	Conditions	Min	Typ	Max	Unit
Junction to Case Thermal Resistance	Rth(j−c)Q	Inverter IGBT Part (per 1/6 Module)	–	–	1.5	°C/W
	Rth(j−c)F	Inverter FRD Part (per 1/6 Module)	–	–	1.8	°C/W

3. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.

Table 4. RECOMMENDED OPERATING RANGES (Note 4)

Rating	Symbol	Conditions	Min	Typ	Max	Unit
Supply Voltage	VPN	P – NU, NV, NW	–	600	800	V
Gate Driver Supply Voltages	VDD	VDD(UH, VH, WH), VDD(L) – VSS	13.5	15	16.5	V
	VBS	VB(U) – VS(U), VB(V) – VS(V), VB(W) – VS(W)	13.0	15	18.5	V
Supply Voltage Variation	dVDD / dt dVBS / dt		−1	–	1	V/μs
PWM Frequency	fPWM		1		20	kHz
Dead Time	DT	Turn−off to Turn−on (external)	3	–	–	μs

Table 4. RECOMMENDED OPERATING RANGES (Note 4) (continued)

Rating	Symbol	Conditions		Min	Typ	Max	Unit
Allowable r.m.s. Current	Io	VPN = 600 V, VDD = VBS = 15 V, P.F. = 0.8, Tc ≤ 125°C, Tj ≤ 150°C, (Note 5)	f_{PWM} = 5 kHz	–	–	11.2	A rms
			f_{PWM} = 15 kHz	–	–	6.3	
Allowable Input Pulse Width	PWIN (on)	400 V ≤ VPN ≤ 800 V, 13.5 V ≤ VDD ≤ 16.5 V, 13.0 V ≤ VBS ≤ 18.5 V, −40°C ≤ Tc ≤ 150°C		2.0	–	–	μs
	PWIN (off)			2.5	–	–	
Package Mounting Torque		M3 Type Screw		0.6	0.7	0.9	Nm

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Allowable r.m.s Current depends on the actual conditions.
5. Flatness tolerance of the heatsink should be within −50 μm to +100 μm.

Table 5. ELECTRICAL CHARACTERISTICS (Tc = 25°C, VD = 15 V, unless otherwise noted) (Note 6)

Parameter		Test Conditions	Symbol	Min	Typ	Max	Unit
INVERTER SECTION							
Collector−Emitter Leakage Current		Vce = Vces, Tj = 25°C	Ices	–	–	1	mA
		Vce = Vces, Tj = 150°C		–	–	10	mA
Collector−Emitter Saturation Voltage		VDD = VBS = 15 V, IN = 5 V Ic = 10 A, Tj = 25°C	VCE(sat)	–	1.85	2.5	V
		VDD = VBS = 15 V, IN = 5 V Ic = 10 A, Tj = 150°C		–	2.0		V
FWDi Forward Voltage		IN = 0 V, If = 10 A, Tj = 25°C	VF	–	1.80	2.6	V
		IN = 0 V, If = 10 A, Tj = 150°C		–	1.70		V
High Side	Switching Times	VPN = 600 V, VDD(H) = VDD(L) = 15 V Ic = 10 A, Tj = 25°C, IN = 0 ⇔ 5 V Inductive Load	ton	0.80	1.40	2.00	μs
			tc (on)	–	0.30	0.60	μs
			toff	–	1.70	2.50	μs
			tc (off)	–	0.20	0.60	μs
			trr	–	0.40	–	μs
Low Side	Switching Times	VPN = 600 V, VDD(H) = VDD(L) = 15 V Ic = 10 A, Tj = 25°C, IN = 0 ⇔ 5 V Inductive Load	ton	0.90	1.50	2.10	μs
			tc (on)	–	0.30	0.60	μs
			toff	–	1.70	2.50	μs
			tc (off)	–	0.20	0.60	μs
			trr	–	0.40	–	μs
DRIVER SECTION							
Quiescent VDD Supply Current		VDD(UH,VH,WH) = 15 V, HIN(U,V,W) = 0 V	VDD(UH) − VSS VDD(VH) − VSS VDD(WH) − VSS	IQDDH	–	–	0.30	mA
		VDD(L) = 15 V, LIN(U, V, W) = 0 V	VDD(L) − VSS	IQDDL	–	–	3.50	mA
Operating VDD Supply Current		VDD(UH, VH, WH) = 15 V, f_{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High−Side	VDD(UH) − VSS VDD(VH) − VSS VDD(WH) − VSS	IPDDH	–	–	0.40	mA
		VDD(L) = 15 V, f_{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for Low−Side	VDD(L) − VSS	IPDDL	–	–	7.00	mA

Table 5. ELECTRICAL CHARACTERISTICS (Tc = 25°C, VD = 15 V, unless otherwise noted) (Note 6) (continued)

Parameter	Test Conditions		Symbol	Min	Typ	Max	Unit
DRIVER SECTION							
Quiescent VBS Supply Current	VBS = 15 V HIN(U, V, W) = 0 V	VB(U) – VS(U) VB(V) – VS(V) VB(W) – VS(W)	IQBS	–	–	0.30	mA
Operating VBS Supply Current	VDD = VBS = 15 V, f_{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High–Side	VB(U) – VS(U) VB(V) – VS(V) VB(W) – VS(W)	IPBS	–	–	6.00	mA
ON Threshold Voltage	HIN(U, V, W) – VSS, LIN(U, V, W) – VSS		VIN(ON)			2.6	V
OFF Threshold Voltage			VIN(OF)	0.8			V
Short Circuit Trip Level	VDD = 15 V, CIN–VSS		VCIN(ref)	0.46	0.48	0.50	V
Supply Circuit Under–Voltage Protection	Detection Level		UVDDD	10.3		12.5	V
	Reset Level		UVDDR	10.8		13.0	V
	Detection Level		UVBSD	10.0		12.0	V
	Reset Level		UVBSR	10.5		12.5	V
Voltage Output for LVIC Temperature Sensing Unit	VTS–VSS = 10 nF, Temp. = 25°C		VTS	(0.905)	(1.030)	(1.155)	V
Fault Output Voltage	VDD = 0 V, CIN = 0 V, VFO Circuit: 10 kΩ to 5 V Pull–up		VFOH	4.9	–	–	V
	VDD = 0 V, CIN = 1 V, VFO Circuit: 10 kΩ to 5 V Pull–up		VFOL	–	–	0.95	V
Fault–Output Pulse Width	CFOD = 22 nF		tFOD	1.6	2.4	–	ms
BOOTSTRAP SECTION							
Bootstrap Diode Forward Current	If = 0.1 A		VF	3.4	4.6	5.8	V
Built–in Limiting Resistance			RBOOT	30	38	46	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Performance guaranteed over the indicated operating temperature range by design and/or characterization tested at $T_J = T_A = 25°C$. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
7. The fault–out pulse width tFOD depends on the capacitance value of CFOD according to the following approximate equation: tFOD = (TBD) x 10^6 x CFOD (s)
8. Values based on design and/or characterization.

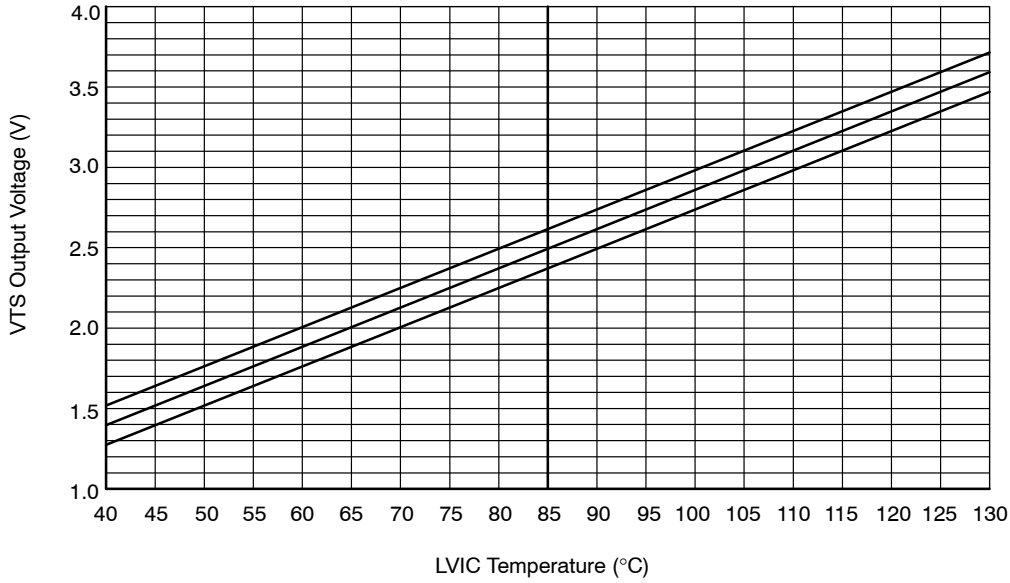
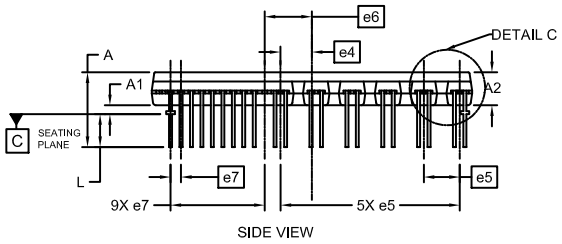


Figure 4. Temperature of LVIC versus VOT Characteristics

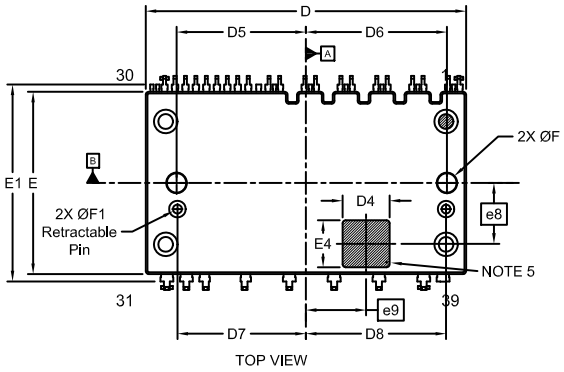
PACKAGE DIMENSIONS

DIP39, 54.5x31.0 EP−2
CASE MODGX
ISSUE O

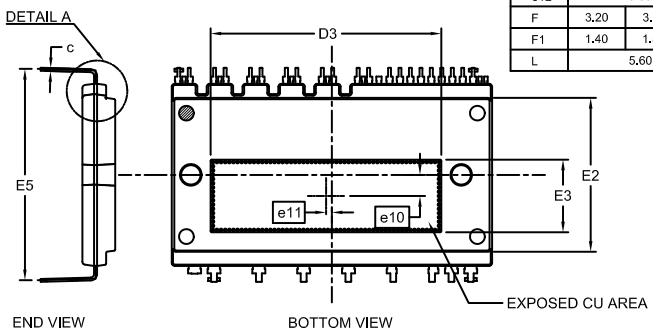
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	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.
A	12.20	12.7	13.2	E	30.90	31.00	31.10
A1	1.00	1.50	2.00	E1	33.50 REF		
A2	5.50	5.60	5.70	E2	26.14 REF		
A3	2.00 REF			E3	12.35 REF		
A4	1.55 REF			E4	8.00 REF		
A5	3.10 REF			E5	35.40	35.90	36.40
b	0.90	1.00	1.10	e	2.81 REF		
b1	1.90	2.00	2.10	e1	7.62 BSC		
b2	0.40	0.50	0.60	e2	6.60 BSC		
b3	1.40	1.50	1.60	e3	3.30 BSC		
c	0.50 REF			e4	5.35 REF		
D	54.40	54.50	54.60	e5	6.10 BSC		
D3	39.25 REF			e6	8.02 REF		
D4	8.00 REF			e7	1.78 BSC		
D5	22.00 REF			e8	10.35 REF		
D6	24.00 REF			e9	10.25 REF		
D7	21.85 REF			e10	3.60 REF		
D8	23.85 REF			e11	1.00 REF		
				e12	0.89 BSC		
				F	3.20	3.30	3.40
				F1	1.40	1.50	1.60
				L	5.60 REF		



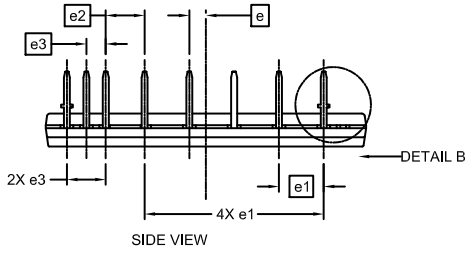
SIDE VIEW



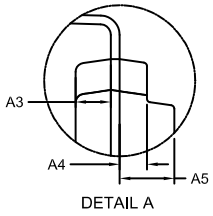
TOP VIEW



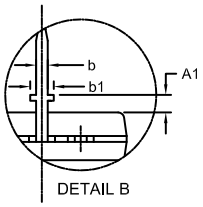
END VIEW
BOTTOM VIEW



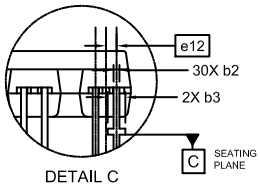
SIDE VIEW



DETAIL A



DETAIL B



DETAIL C

NOTES:
1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP.
4. POSITION OF THE LEAD IS DETERMINED AT THE BASE OF THE LEAD WHERE IT EXITS THE PACKAGE BODY.
5. AREA FOR 2D BAR CODE.
6. SHORTENED/CUT PINS ARE 2,5,8,11,14,17,19,29, 30 AND 39.

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